74HC373; 74HCT373

Octal D-type transparent latch; 3-state

Product data sheet

1. General description

The 74HC373; 74HCT373 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL. It is specified in compliance with JEDEC standard no. 7A.

The 74HC373; 74HCT373 is an octal D-type transparent latch featuring separate D-type inputs for each latch and 3-state outputs for bus oriented applications. A latch enable (LE) input and an output enable ($\overline{OE}$) input are common to all latches.

The 74HC373; HCT373 consists of eight D-type transparent latches with 3-state true outputs. When LE is HIGH, data at the Dn inputs enters the latches. In this condition the latches are transparent, i.e. a latch output will change state each time its corresponding D input changes.

When LE is LOW the latches store the information that was present at the D inputs a set-up time preceding the HIGH-to-LOW transition of LE. When $\overline{OE}$ is LOW, the contents of the 8 latches are available at the outputs. When $\overline{OE}$ is HIGH, the outputs go to the high-impedance OFF-state. Operation of the $\overline{OE}$ input does not affect the state of the latches.

The 74HC373; 74HCT373 is functionally identical to:

- 74HC533; 74HCT533: but inverted outputs
- 74HC563; 74HCT563: but inverted outputs and different pin arrangement
- 74HC573; 74HCT573: but different pin arrangement

2. Features

- 3-state non-inverting outputs for bus oriented applications
- Common 3-state output enable input
- Functionally identical to the 74HC563; 74HCT563, 74HC573; 74HCT573 and 74HC533; 74HCT533
- ESD protection:
  - HBM EIA/JESD22-A114-C exceeds 2 000 V
  - MM EIA/JESD22-A115-A exceeds 200 V
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C

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3. Quick reference data

Table 1: Quick reference data

GND = 0 V; T_{amb} = 25 °C; $t_r = t_f$ = 6 ns.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
74HC373							
t_{PHL}, t_{PLH}	propagation delay	V_{CC} = 5 V; C_L = 15 pF					
	Dn to Qn			-	12	-	ns
	LE to Qn			-	15	-	ns
C_i	input capacitance			-	3.5	-	pF
C_{PD}	power dissipation capacitance	per latch; V_I = GND to V_{CC}	[1]	-	45	-	pF
74HCT373							
t_{PHL}, t_{PLH}	propagation delay	V_{CC} = 5 V; C_L = 15 pF					
	Dn to Qn			-	14	-	ns
	LE to Qn			-	13	-	ns
C_i	input capacitance			-	3.5	-	pF
C_{PD}	power dissipation capacitance	per latch; V_I = GND to (V_{CC} – 1.5 V)	[1]	-	41	-	pF

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

4. Ordering information

Table 2: Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74HC373				
74HC373N	–40 °C to +125 °C	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1
74HC373D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74HC373DB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74HC373PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74HC373BQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1

Table 2: Ordering information *…continued*

Type number	Package			
	Temperature range	Name	Description	Version
74HCT373				
74HCT373N	–40 °C to +125 °C	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1
74HCT373D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74HCT373DB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74HCT373PW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74HCT373BQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 × 4.5 × 0.85 mm	SOT764-1

5. Functional diagram

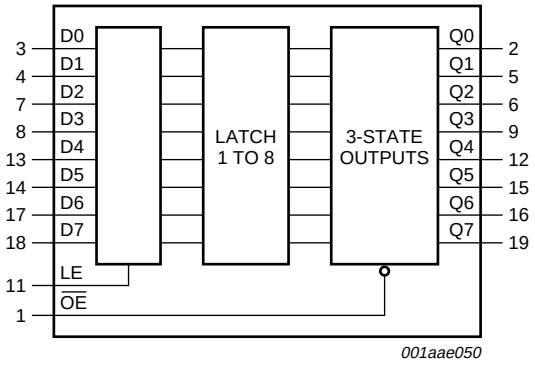


Fig 1. Functional diagram

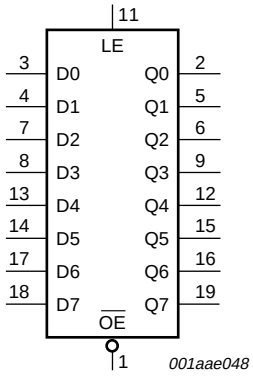


Fig 2. Logic symbol

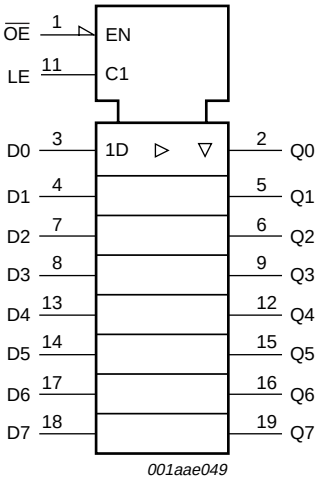


Fig 3. IEC logic symbol

8. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			–0.5	+7	V
I_{IK}	input clamping current	$V_I < –0.5$ V or $V_I > V_{CC} + 0.5$ V		-	±20	mA
I_{OK}	output clamping current	$V_O < –0.5$ V or $V_O > V_{CC} + 0.5$ V		-	±20	mA
I_O	output current	$V_O = –0.5$ V to ($V_{CC} + 0.5$ V)		-	±35	mA
I_{CC}	quiescent supply current			-	+70	mA
I_{GND}	ground current			-	–70	mA
T_{stg}	storage temperature			–65	+150	°C
P_{tot}	total power dissipation					
	DIP20 package		[1]	-	750	mW
	SO20 package		[2]	-	500	mW
	SSOP20 package		[3]		500	mW
	TSSOP20 package		[3]		500	mW
	DHVQFN20 package		[4]	-	500	mW

[1] For DIP20 package: P_{tot} derates linearly with 12 mW/K above 70 °C.

[2] For SO20: P_{tot} derates linearly with 8 mW/K above 70 °C.

[3] For SSOP20 and TSSOP20 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

[4] For DHVQFN20 package: P_{tot} derates linearly with 4.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 6: Recommended operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
74HC373						
V_{CC}	supply voltage		2.0	5.0	6.0	V
V_I	input voltage		0	-	V_{CC}	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature		–40	+25	+125	°C
t_r, t_f	input rise and fall time	$V_{CC} = 2.0$ V	-	-	1000	ns
		$V_{CC} = 4.5$ V	-	6.0	500	ns
		$V_{CC} = 6.0$ V	-	-	400	ns
74HCT373						
V_{CC}	supply voltage		4.5	5.0	5.5	V
V_I	input voltage		0	-	V_{CC}	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature		–40	+25	+125	°C
t_r, t_f	input rise and fall time	$V_{CC} = 4.5$ V	-	6.0	500	ns

10. Static characteristics

Table 7: Static characteristics 74HC373

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{IH}	HIGH-state input voltage	V_{CC} = 2.0 V	1.5	1.2	-	V
		V_{CC} = 4.5 V	3.15	2.4	-	V
		V_{CC} = 6.0 V	4.2	3.2	-	V
V_{IL}	LOW-state input voltage	V_{CC} = 2.0 V	-	0.8	0.5	V
		V_{CC} = 4.5 V	-	2.1	1.35	V
		V_{CC} = 6.0 V	-	2.8	1.8	V
V_{OH}	HIGH-state output voltage	V_I = V_{IH} or V_{IL}	-	-	-	
		I_O = –20 µA; V_{CC} = 2.0 V	1.9	2.0	-	V
		I_O = –20 µA; V_{CC} = 4.5 V	4.4	4.5	-	V
		I_O = –20 µA; V_{CC} = 6.0 V	5.9	6.0	-	V
		I_O = –6.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	V
		I_O = –7.8 mA; V_{CC} = 6.0 V	5.48	5.81	-	V
V_{OL}	LOW-state output voltage	V_I = V_{IH} or V_{IL}				
		I_O = 20 µA; V_{CC} = 2.0 V	-	0	0.1	V
		I_O = 20 µA; V_{CC} = 4.5 V	-	0	0.1	V
		I_O = 20 µA; V_{CC} = 6.0 V	-	0	0.1	V
		I_O = 6.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	V
		I_O = 7.8 mA; V_{CC} = 6.0 V	-	0.16	0.26	V
I_{LI}	input leakage current	V_I = V_{CC} or GND; V_{CC} = 6.0 V	-	-	±0.1	µA
I_{OZ}	OFF-state output current	V_I = V_{IH} or V_{IL}; V_{CC} = 6.0 V; V_O = V_{CC} or GND	-	-	±0.5	µA
I_{CC}	quiescent supply current	V_{CC} = 6.0 V; I_O = 0 A; V_I = V_{CC} or GND	-	-	8.0	µA
C_i	input capacitance		-	3.5	-	pF
T_{amb} = –40 °C to +85 °C						
V_{IH}	HIGH-state input voltage	V_{CC} = 2.0 V	1.5	-	-	V
		V_{CC} = 4.5 V	3.15	-	-	V
		V_{CC} = 6.0 V	4.2	-	-	V
V_{IL}	LOW-state input voltage	V_{CC} = 2.0 V	-	-	0.5	V
		V_{CC} = 4.5 V	-	-	1.35	V
		V_{CC} = 6.0 V	-	-	1.8	V
V_{OH}	HIGH-state output voltage	V_I = V_{IH} or V_{IL}				
		I_O = –20 µA; V_{CC} = 2.0 V	1.9	-	-	V
		I_O = –20 µA; V_{CC} = 4.5 V	4.4	-	-	V
		I_O = –20 µA; V_{CC} = 6.0 V	5.9	-	-	V
		I_O = –6.0 mA; V_{CC} = 4.5 V	3.84	-	-	V
		I_O = –7.8 mA; V_{CC} = 6.0 V	5.34	-	-	V

Table 7: Static characteristics 74HC373 *…continued*

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OL}	LOW-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = 20 µA; V_{CC} = 2.0 V	-	-	0.1	V
		I_O = 20 µA; V_{CC} = 4.5 V	-	-	0.1	V
		I_O = 20 µA; V_{CC} = 6.0 V	-	-	0.1	V
		I_O = 6.0 mA; V_{CC} = 4.5 V	-	-	0.33	V
		I_O = 7.8 mA; V_{CC} = 6.0 V	-	-	0.33	V
I_{LI}	input leakage current	$V_I = V_{CC}$ or GND; V_{CC} = 6.0 V	-	-	±1.0	µA
I_{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}; V_{CC} = 6.0 V; $V_O = V_{CC}$ or GND	-	-	±5.0	µA
I_{CC}	quiescent supply current	V_{CC} = 6.0 V; I_O = 0 A; $V_I = V_{CC}$ or GND		-	80	µA
T_{amb} = −40 °C to +125 °C						
V_{IH}	HIGH-state input voltage	V_{CC} = 2.0 V	1.5	-	-	V
		V_{CC} = 4.5 V	3.15	-	-	V
		V_{CC} = 6.0 V	4.2	-	-	V
V_{IL}	LOW-state input voltage	V_{CC} = 2.0 V	-	-	0.5	V
		V_{CC} = 4.5 V	-	-	1.35	V
		V_{CC} = 6.0 V	-	-	1.8	V
V_{OH}	HIGH-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = −20 µA; V_{CC} = 2.0 V	1.9	-	-	V
		I_O = −20 µA; V_{CC} = 4.5 V	4.4	-	-	V
		I_O = −20 µA; V_{CC} = 6.0 V	5.9	-	-	V
		I_O = −6.0 mA; V_{CC} = 4.5 V	3.7	-	-	V
		I_O = −7.8 mA; V_{CC} = 6.0 V	5.2	-	-	V
V_{OL}	LOW-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = 20 µA; V_{CC} = 2.0 V	-	-	0.1	V
		I_O = 20 µA; V_{CC} = 4.5 V	-	-	0.1	V
		I_O = 20 µA; V_{CC} = 6.0 V	-	-	0.1	V
		I_O = 6.0 mA; V_{CC} = 4.5 V	-	-	0.4	V
		I_O = 7.8 mA; V_{CC} = 6.0 V	-	-	0.4	V
I_{LI}	input leakage current	$V_I = V_{CC}$ or GND; V_{CC} = 6.0 V	-	-	±1.0	µA
I_{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}; V_{CC} = 6.0 V; $V_O = V_{CC}$ or GND	-	-	±10.0	µA
I_{CC}	quiescent supply current	V_{CC} = 6.0 V; I_O = 0 A; $V_I = V_{CC}$ or GND	-	-	160	µA

Table 8: Static characteristics 74HCT373

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{IH}	HIGH-state input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	1.6	-	V
V_{IL}	LOW-state input voltage	V_{CC} = 4.5 V to 5.5 V	-	1.2	0.8	V
V_{OH}	HIGH-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = –20 µA; V_{CC} = 4.5 V	4.4	4.5	-	V
		I_O = –6.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	V
V_{OL}	LOW-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = 20 µA; V_{CC} = 4.5 V	-	0.0	0.1	V
		I_O = 6.0 mA; V_{CC} = 4.5 V	-	0.16	0.26	V
I_{LI}	input leakage current	$V_I = V_{CC}$ or GND; V_{CC} = 5.5 V	-	-	±0.1	µA
I_{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}; V_{CC} = 5.5 V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; I_O = 0 A	-	-	±0.5	µA
I_{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; I_O = 0 A; V_{CC} = 5.5 V	-	-	8.0	µA
ΔI_{CC}	additional quiescent supply current	$V_I = V_{CC}$ – 2.1 V; other inputs at V_{CC} or GND; V_{CC} = 4.5 V to 5.5 V; I_O = 0 A				
	Dn		-	30	108	µA
	LE		-	150	540	µA
	$\overline{OE}$		-	100	360	µA
C_i	input capacitance		-	3.5	-	pF
T_{amb} = –40 °C to +85 °C						
V_{IH}	HIGH-state input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V_{IL}	LOW-state input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V_{OH}	HIGH-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = –20 µA; V_{CC} = 4.5 V	4.4	-	-	V
		I_O = –6.0 µA; V_{CC} = 4.5 V	3.84	-	-	V
V_{OL}	LOW-state output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = 20 µA; V_{CC} = 4.5 V	-	-	0.1	V
		I_O = 6.0 mA; V_{CC} = 4.5 V	-	-	0.33	V
I_{LI}	input leakage current	$V_I = V_{CC}$ or GND; V_{CC} = 5.5 V	-	-	±1.0	µA
I_{OZ}	OFF-state output current	$V_I = V_{IH}$ or V_{IL}; V_{CC} = 5.5 V; $V_O = V_{CC}$ or GND per input pin; other inputs at V_{CC} or GND; I_O = 0 A	-	-	±5.0	µA
I_{CC}	quiescent supply current	$V_I = V_{CC}$ or GND; I_O = 0 A; V_{CC} = 5.5 V	-	-	80	µA
ΔI_{CC}	additional quiescent supply current	$V_I = V_{CC}$ – 2.1 V; other inputs at V_{CC} or GND; V_{CC} = 4.5 V to 5.5 V; I_O = 0 A				
	Dn		-	-	135	µA
	LE		-	-	675	µA
	$\overline{OE}$		-	-	450	µA

Table 8: Static characteristics 74HCT373 *…continued*

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = −40 °C to +125 °C						
V_{IH}	HIGH-state input voltage	V_{CC} = 4.5 V to 5.5 V	2.0	-	-	V
V_{IL}	LOW-state input voltage	V_{CC} = 4.5 V to 5.5 V	-	-	0.8	V
V_{OH}	HIGH-state output voltage	V_I = V_{IH} or V_{IL}				
		I_O = −20 µA; V_{CC} = 4.5 V	4.4	-	-	V
		I_O = −6.0 mA; V_{CC} = 4.5 V	3.7	-	-	V
V_{OL}	LOW-state output voltage	V_I = V_{IH} or V_{IL}				
		I_O = 20 µA; V_{CC} = 4.5 V	-	-	0.1	V
		I_O = 6.0 mA; V_{CC} = 4.5 V	-	-	0.4	V
I_{LI}	input leakage current	V_I = V_{CC} or GND; V_{CC} = 5.5 V	-	-	±1.0	µA
I_{OZ}	OFF-state output current	V_I = V_{IH} or V_{IL}; V_{CC} = 5.5 V; V_O = V_{CC} or GND per input pin; other inputs at V_{CC} or GND; I_O = 0 A	-	-	±10	µA
I_{CC}	quiescent supply current	V_I = V_{CC} or GND; I_O = 0 A; V_{CC} = 5.5 V	-	-	160	µA
ΔI_{CC}	additional quiescent supply current	V_I = V_{CC} − 2.1 V; other inputs at V_{CC} or GND; V_{CC} = 4.5 V to 5.5 V; I_O = 0 A				
	Dn		-	-	147	µA
	LE		-	-	735	µA
	$\overline{OE}$		-	-	490	µA

11. Dynamic characteristics

Table 9: Dynamic characteristics 74HC373

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
t_{PHL}, t_{PLH}	propagation delay					
	Dn to Qn	see Figure 8				
		V_{CC} = 2.0 V	-	41	150	ns
		V_{CC} = 4.5 V	-	15	30	ns
		V_{CC} = 5 V; C_L = 15 pF	-	12	-	ns
		V_{CC} = 6.0 V	-	12	26	ns
	LE to Qn	see Figure 9				
		V_{CC} = 2.0 V	-	50	175	ns
		V_{CC} = 4.5 V	-	18	35	ns
		V_{CC} = 5 V; C_L = 15 pF	-	15	-	ns
		V_{CC} = 6.0 V	-	14	30	ns

Table 9: Dynamic characteristics 74HC373 *...continued*

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
t_{PZH}, t_{PZL}	3-state output enable time $\overline{OE}$ to Qn	see Figure 10					
		V_{CC} = 2.0 V		-	44	150	ns
		V_{CC} = 4.5 V		-	16	30	ns
		V_{CC} = 6.0 V		-	13	26	ns
t_{PHZ}, t_{PLZ}	3-state output disable time $\overline{OE}$ to Qn	see Figure 10					
		V_{CC} = 2.0 V		-	47	150	ns
		V_{CC} = 4.5 V		-	17	30	ns
		V_{CC} = 6.0 V		-	14	26	ns
t_{THL}, t_{TLH}	output transition time	see Figure 9					
		V_{CC} = 2.0 V		-	14	60	ns
		V_{CC} = 4.5 V		-	5	12	ns
		V_{CC} = 6.0 V		-	4	10	ns
t_W	pulse width LE HIGH	see Figure 9					
		V_{CC} = 2.0 V		80	17	-	ns
		V_{CC} = 4.5 V		16	6	-	ns
		V_{CC} = 6.0 V		14	5	-	ns
t_{su}	set-up time Dn to LE	see Figure 11					
		V_{CC} = 2.0 V		50	14	-	ns
		V_{CC} = 4.5 V		10	5	-	ns
		V_{CC} = 6.0 V		9	4	-	ns
t_h	hold time Dn to LE	see Figure 11					
		V_{CC} = 2.0 V		+5	–8	-	ns
		V_{CC} = 4.5 V		+5	–3	-	ns
		V_{CC} = 6.0 V		+5	–2	-	ns
C_{PD}	power dissipation capacitance	per latch; V_I = GND to V_{CC}	[1]	-	45	-	pF
T_{amb} = –40 °C to +85 °C							
t_{PHL}, t_{PLH}	propagation delay						
	Dn to Qn	see Figure 8					
		V_{CC} = 2.0 V		-	-	190	ns
		V_{CC} = 4.5 V		-	-	38	ns
		V_{CC} = 6.0 V		-	-	33	ns
	LE to Qn	see Figure 9					
		V_{CC} = 2.0 V		-	-	220	ns
		V_{CC} = 4.5 V		-	-	44	ns
		V_{CC} = 6.0 V		-	-	37	ns
t_{PZH}, t_{PZL}	3-state output enable time $\overline{OE}$ to Qn	see Figure 10					
		V_{CC} = 2.0 V		-	-	190	ns
		V_{CC} = 4.5 V		-	-	38	ns
		V_{CC} = 6.0 V		-	-	33	ns

Table 9: Dynamic characteristics 74HC373 *...continued*

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_{PHZ}, t_{PLZ}	3-state output disable time $\overline{OE}$ to Qn	see Figure 10				
		V_{CC} = 2.0 V	-	-	190	ns
		V_{CC} = 4.5 V	-	-	38	ns
		V_{CC} = 6.0 V	-	-	33	ns
t_{THL}, t_{TLH}	output transition time	see Figure 8				
		V_{CC} = 2.0 V	-	-	75	ns
		V_{CC} = 4.5 V	-	-	15	ns
		V_{CC} = 6.0 V	-	-	13	ns
t_W	pulse width LE HIGH	see Figure 9				
		V_{CC} = 2.0 V	100	-	-	ns
		V_{CC} = 4.5 V	20	-	-	ns
		V_{CC} = 6.0 V	17	-	-	ns
t_{su}	set-up time Dn to LE	see Figure 11				
		V_{CC} = 2.0 V	65	-	-	ns
		V_{CC} = 4.5 V	13	-	-	ns
		V_{CC} = 6.0 V	11	-	-	ns
t_h	hold time Dn to LE	see Figure 11				
		V_{CC} = 2.0 V	5	-	-	ns
		V_{CC} = 4.5 V	5	-	-	ns
		V_{CC} = 6.0 V	5	-	-	ns
T_{amb} = −40 °C to +125 °C						
t_{PHL}, t_{PLH}	propagation delay					
	Dn to Qn	see Figure 8				
		V_{CC} = 2.0 V	-	-	225	ns
		V_{CC} = 4.5 V	-	-	45	ns
		V_{CC} = 6.0 V	-	-	38	ns
	LE to Qn	see Figure 9				
		V_{CC} = 2.0 V	-	-	265	ns
		V_{CC} = 4.5 V	-	-	53	ns
		V_{CC} = 6.0 V	-	-	45	ns
t_{PZH}, t_{PZL}	3-state output enable time $\overline{OE}$ to Qn	see Figure 10				
		V_{CC} = 2.0 V	-	-	225	ns
		V_{CC} = 4.5 V	-	-	45	ns
		V_{CC} = 6.0 V	-	-	38	ns
t_{PHZ}, t_{PLZ}	3-state output disable time $\overline{OE}$ to Qn	see Figure 10				
		V_{CC} = 2.0 V	-	-	225	ns
		V_{CC} = 4.5 V	-	-	45	ns
		V_{CC} = 6.0 V	-	-	38	ns

Table 9: Dynamic characteristics 74HC373 *...continued*

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_{THL}, t_{TLH}	output transition time	see Figure 8				
		V_{CC} = 2.0 V	-	-	90	ns
		V_{CC} = 4.5 V	-	-	18	ns
		V_{CC} = 6.0 V	-	-	15	ns
t_W	pulse width LE HIGH	see Figure 9				
		V_{CC} = 2.0 V	120	-	-	ns
		V_{CC} = 4.5 V	24	-	-	ns
		V_{CC} = 6.0 V	20	-	-	ns
t_{su}	set-up time Dn to LE	see Figure 11				
		V_{CC} = 2.0 V	75	-	-	ns
		V_{CC} = 4.5 V	15	-	-	ns
		V_{CC} = 6.0 V	13	-	-	ns
t_h	hold time Dn to LE	see Figure 11				
		V_{CC} = 2.0 V	5	-	-	ns
		V_{CC} = 4.5 V	5	-	-	ns
		V_{CC} = 6.0 V	5	-	-	ns

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

Table 10: Dynamic characteristics 74HCT373

Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
t_{PHL}, t_{PLH}	propagation delay					
	Dn to Qn	see Figure 8				
		V_{CC} = 4.5 V	-	17	30	ns
		V_{CC} = 5 V; C_L = 15 pF	-	14	-	ns
	LE to Qn	see Figure 9				
		V_{CC} = 4.5 V	-	16	32	ns
		V_{CC} = 5 V; C_L = 15 pF	-	13	-	ns
t_{PZH}, t_{PZL}	3-state output enable time $\overline{OE}$ to Qn	V_{CC} = 4.5 V; see Figure 10	-	19	32	ns
t_{PHZ}, t_{PLZ}	3-state output disable time $\overline{OE}$ to Qn	V_{CC} = 4.5 V; see Figure 10	-	18	30	ns
t_{THL}, t_{TLH}	output transition time	V_{CC} = 4.5 V; see Figure 8	-	5	12	ns

Table 10: Dynamic characteristics 74HCT373 *...continued*

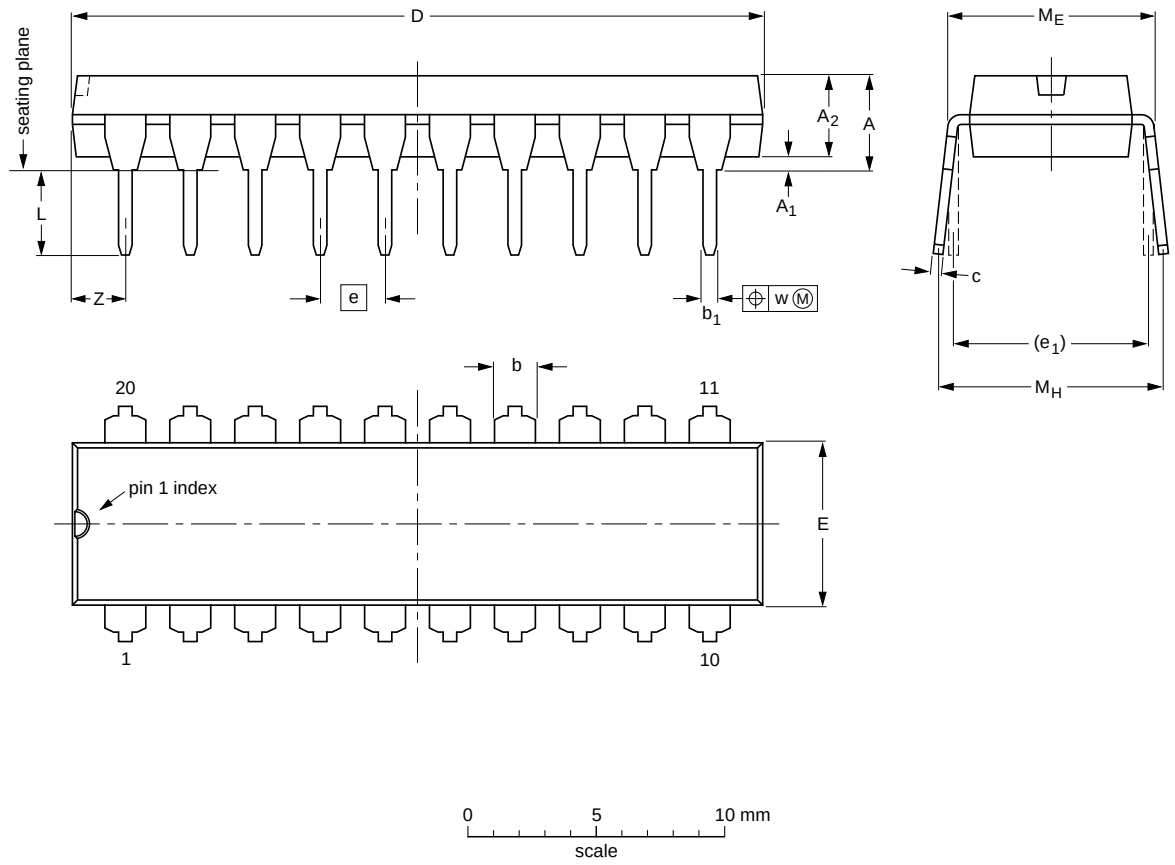
Voltages are referenced to GND (ground = 0 V); C_L = 50 pF unless otherwise specified; for test circuit see Figure 12.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
t_W	pulse width LE HIGH	V_{CC} = 4.5 V; see Figure 9		16	4	-	ns
t_{su}	set-up time Dn to LE	V_{CC} = 4.5 V; see Figure 11		12	6	-	ns
t_h	hold time Dn to LE	V_{CC} = 4.5 V; see Figure 11		4	–1	-	ns
C_{PD}	power dissipation capacitance	per latch; V_I = GND to (V_{CC} – 1.5 V)	[1]	-	41	-	pF
T_{amb} = –40 °C to +85 °C							
t_{PHL}, t_{PLH}	propagation delay						
	Dn to Qn	V_{CC} = 4.5 V; see Figure 8		-	-	38	ns
	LE to Qn	V_{CC} = 4.5 V; see Figure 9		-	-	40	ns
t_{PZH}, t_{PZL}	3-state output enable time $\overline{OE}$ to Qn	V_{CC} = 4.5 V; see Figure 10		-	-	40	ns
t_{PHZ}, t_{PLZ}	3-state output disable time $\overline{OE}$ to Qn	V_{CC} = 4.5 V; see Figure 10		-	-	38	ns
t_{THL}, t_{TLH}	output transition time	V_{CC} = 4.5 V; see Figure 8		-	-	15	ns
t_W	pulse width LE HIGH	V_{CC} = 4.5 V; see Figure 9		20	-	-	ns
t_{su}	set-up time Dn to LE	V_{CC} = 4.5 V; see Figure 11		15	-	-	ns
t_h	hold time Dn to LE	V_{CC} = 4.5 V; see Figure 11		4	-	-	ns
T_{amb} = –40 °C to +125 °C							
t_{PHL}, t_{PLH}	propagation delay						
	Dn to Qn	V_{CC} = 4.5 V; see Figure 8		-	-	45	ns
	LE to Qn	V_{CC} = 4.5 V; see Figure 9		-	-	48	ns
t_{PZH}, t_{PZL}	3-state output enable time $\overline{OE}$ to Qn	V_{CC} = 4.5 V, see Figure 10		-	-	48	ns
t_{PHZ}, t_{PLZ}	3-state output disable time $\overline{OE}$ to Qn	V_{CC} = 4.5 V; see Figure 10		-	-	45	ns
t_{THL}, t_{TLH}	output transition time	V_{CC} = 4.5 V; see Figure 8		-	-	18	ns
t_W	pulse width LE HIGH	V_{CC} = 4.5 V; see Figure 8		24	-	-	ns
t_{su}	set-up time Dn to LE	V_{CC} = 4.5 V; see Figure 11		18	-	-	ns
t_h	hold time Dn to LE	V_{CC} = 4.5 V; see Figure 11		4	-	-	ns

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in µW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

13. Package outline

DIP20: plastic dual in-line package; 20 leads (300 mil) **SOT146-1**



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A_1 min.	A_2 max.	b	b_1	c	D (1)	E (1)	e	e_1	L	M_E	M_H	w	Z (1) max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	0.36 0.23	26.92 26.54	6.40 6.22	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2
inches	0.17	0.02	0.13	0.068 0.051	0.021 0.015	0.014 0.009	1.060 1.045	0.25 0.24	0.1	0.3	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.078

Note

1. Plastic or metal protrusions of 0.25 mm (0.01 inch) maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	
	IEC	JEDEC	JEITA			
SOT146-1		MS-001	SC-603			

Fig 13. Package outline SOT146-1 (DIP20)